AAP Gen 7 (TO-240AA) Power Modules Thyristor/Diode and Thyristor/Thyristor, 27 A



ADD-A-PAK

PRIMARY CHARACTERISTICS				
I _{T(AV)} or I _{F(AV)}	27 A			
Туре	Modules - thyristor, standard			
Package	AAP Gen 7 (TO-240AA)			

MECHANICAL DESCRIPTION

The AAP Gen 7 (TO-240AA), new generation of APP module, combines the excellent thermal performances obtained by the usage of exposed direct bonded copper substrate, with advanced compact simple package solution and simplified internal structure with minimized number of interfaces.

FEATURES

- · High voltage
- · Industrial standard package
- UL approved file E78996



- · Low thermal resistance
- · Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- Excellent thermal performances obtained by the usage of exposed direct bonded copper substrate
- Up to 1600 V
- High surge capability
- Easy mounting on heatsink

ELECTRICAL DESCRIPTION

These modules are intended for general purpose high voltage applications such as high voltage regulated power supplies, lighting circuits, temperature and motor speed control circuits, UPS and battery charger.

MAJOR RATINGS AND CHARACTERISTICS					
SYMBOL	CHARACTERISTICS	VALUES	UNITS		
I _{T(AV)} or I _{F(AV)}	85 °C	27			
I _{O(RMS)}	As AC switch	60	۸		
I _{TSM,}	50 Hz	400	A		
I _{FSM}	60 Hz	420			
I ² t	50 Hz	800	kA ² s		
1-1	60 Hz	730	KA-S		
I ² √t		8000	kA²√s		
V _{RRM}	Range	400 to 1600	V		
T _{Stg}		-40 to +125	°C		
T _J		-40 to +125	°C		

VS-VSKT26.., VS-VSKH26.., VS-VSKL26.., VS-VSKN26.. Series

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ELECTRICAL SPECIFICATIONS

VOLTAGE RA	ATINGS				
TYPE NUMBER	VOLTAGE CODE	V _{RRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	V _{DRM} , MAXIMUM REPETITIVE PEAK OFF-STATE VOLTAGE, GATE OPEN CIRCUIT V	I _{RRM,} I _{DRM} AT 125 °C mA
	04	400	500	400	
	06	600	700	600	
	08	800	900	800	
VS-VSK.26	10	1000	1100	1000	15
	12	1200	1300	1200	
	14	1400	1500	1400	
	16	1600	1700	1600	

ON-STATE CONDUCTION						
PARAMETER	SYMBOL		TEST CONDITIONS		VALUES	UNITS
Maximum average on-state current (thyristors)	I _{T(AV)}	180° conduction	180° conduction, half sine wave,		27	
Maximum average forward current (diodes)	I _{F(AV)}	$T_C = 85 ^{\circ}C$			21	
Maximum continuous RMS on-state current, as AC switch	I _{O(RMS)}	-	or °	I _(RMS)	60	Α
		t = 10 ms	No voltage		400	
Maximum peak, one-cycle non-repetitive	I _{TSM}	t = 8.3 ms	reapplied	Sinusoidal half wave,	420	
on-state or forward current	or I _{FSM}	t = 10 ms	100 % V _{RRM}	initial $T_J = T_J$ maximum	335	
	T OW	t = 8.3 ms	reapplied	0 0	350	
	t = 10 i		No voltage		800	
Maximum I ² t for fusing	l ² t	t = 8.3 ms	reapplied	laitial T. T. association	730	A ² s
		t = 10 ms	100 % V _{RRM}	Initial $T_J = T_J$ maximum	560	
		t = 8.3 ms	reapplied		510	
Maximum $I^2\sqrt{t}$ for fusing	I ² √t ⁽¹⁾		t = 0.1 ms to 10 ms, no voltage reapplied $T_J = T_J$ maximum			A²√s
Maximum value or threshold voltage	V _{T(TO)} (2)	Low level $^{(3)}$ $T_J = T_J \text{ maximum}$		0.86	V	
waximum value or threshold voltage	VT(TO) (-)	High level (4)	ıj= ıjınaxın	IUIII	1.09	V
Maximum value of on-state	r _t ⁽²⁾	Low level (3)	T. – T. mayin	auma	9.58	mΩ
slope resistance	't (-)	High level (4)	$T_J = T_J$ maximum		7.31	11122
Maximum peak on-state or forward voltage	V_{TM}	$I_{TM} = \pi \times I_{T(AV)}$	T _ 05 °C		1.65	V
Maximum peak on-state or forward voltage	V_{FM}	$I_{FM} = \pi \times I_{F(AV)}$ $T_{J} = 25 \text{ °C}$		1.05	V	
Maximum non-repetitive rate of rise of turned on current	dl/dt	$T_J = 25 ^{\circ}\text{C}$, from 0.67 V_{DRM} , $I_{TM} = \pi \times I_{T(AV)}$, $I_q = 500 \text{mA}$, $t_r < 0.5 \mu\text{s}$, $t_p > 6 \mu\text{s}$			150	A/μs
Maximum holding current	I _H	$T_J = 25$ °C, anode supply = 6 V, resistive load, gate open circuit			200	mA
Maximum latching current	ΙL	T _J = 25 °C, and	ode supply = 6	V, resistive load	400	

Notes

⁽¹⁾ I^2t for time $t_x = I^2\sqrt{t} \times \sqrt{t_x}$

⁽²⁾ Average power = $V_{T(TO)} \times I_{T(AV)} + r_t \times (I_{T(RMS)})^2$

^{(3) 16.7 %} $\times \pi \times I_{AV} < I < \pi \times I_{AV}$

 $^{^{(4)}}$ $I > \pi \times I_{AV}$

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TRIGGERING						
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS	
Maximum peak gate power	P _{GM}			10	W	
Maximum average gate power	P _{G(AV)}			2.5	VV	
Maximum peak gate current	I _{GM}			2.5	Α	
Maximum peak negative gate voltage	-V _{GM}			10		
Maximum gate voltage required to trigger	V _{GT}	T _J = -40 °C	Anode supply = 6 V	4.0	V	
		T _J = 25 °C		2.5		
		T _J = 125 °C	Tesistive load	1.7		
		T _J = -40 °C		270		
Maximum gate current required to trigger	I _{GT}	T _J = 25 °C	Anode supply = 6 V resistive load	150	mA	
		T _J = 125 °C	Tesistive load	80		
Maximum gate voltage that will not trigger	V_{GD}	T _J = 125 °C, rated V _{DRM} applied		0.25	V	
Maximum gate current that will not trigger	I _{GD}	T _J = 125 °C, rated V _{DRI}	_M applied	6	mA	

BLOCKING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum peak reverse and off-state leakage current at V _{RRM} , V _{DRM}	I _{RRM,} I _{DRM}	T _J = 125 °C, gate open circuit	15	mA
Maximum RMS insulation voltage	V _{INS}	50 Hz	3000 (1 min) 3600 (1 s)	V
Maximum critical rate of rise of off-state voltage	dV/dt	$T_J = 125$ °C, linear to 0.67 V_{DRM}	1000	V/µs

THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Junction operating and storage temperature range		T _J , T _{Stg}		-40 to +125	°C
Maximum internal thermal resist junction to case per leg	ance,	R _{thJC}	DC operation	0.76	°C ///
Typical thermal resistance, case to heatsink per module		R _{thCS}	Mounting surface flat, smooth and greased	0.1 °C/W	
Mounting targue + 10.0/	to heatsink		A mounting compound is recommended and the torque should be rechecked after a period of	4	Nm
Mounting torque ± 10 % busbar			3 hours to allow for the spread of the compound.	3	INIII
Approximate weight				75	g
Approximate weight				2.7	OZ.
Case style			JEDEC®	AAP Gen 7	(TO-240AA)

∆R CONDU	CTION F	ER JUN	CTION								
DEVICES	5	SINE HALF	WAVE CO	NDUCTION	N	RE	CTANGUL	AR WAVE C	CONDUCTION	NC	UNITS
DEVICES	180°	120°	90°	60°	30°	180°	120°	90°	60°	30°	UNITS
VSK.26	0.212	0.258	0.330	0.466	0.72	0.166	0.276	0.357	0.482	0.726	°C/W

Note

• Table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

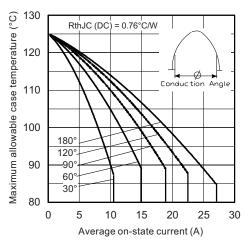


Fig. 1 - Current Ratings Characteristics

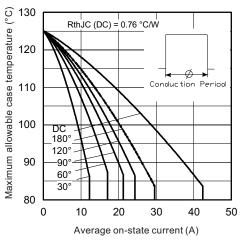


Fig. 2 - Current Ratings Characteristics

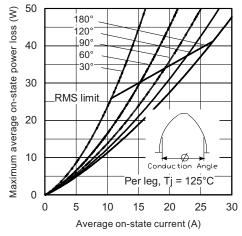


Fig. 3 - On-State Power Loss Characteristics

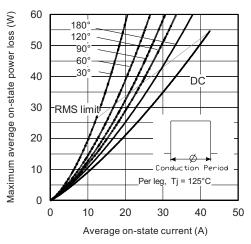
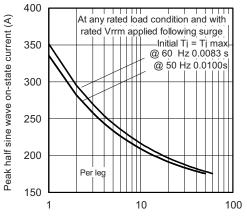


Fig. 4 - On-State Power Loss Characteristics



Number of equal amplitude half cycle current pulses (N)

Fig. 5 - Maximum Non-Repetitive Surge Current

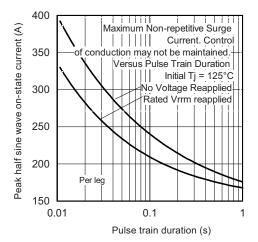


Fig. 6 - Maximum Non-Repetitive Surge Current

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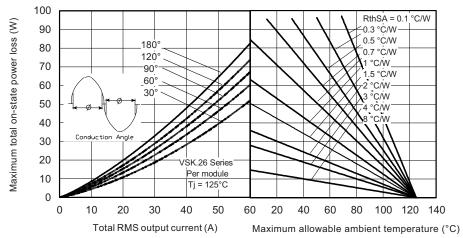


Fig. 7 - On-State Power Loss Characteristics

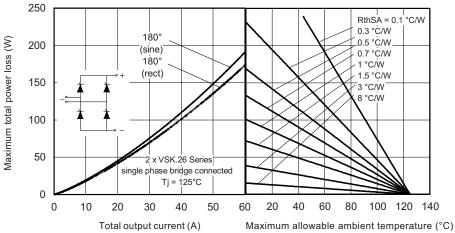


Fig. 8 - On-State Power Loss Characteristics

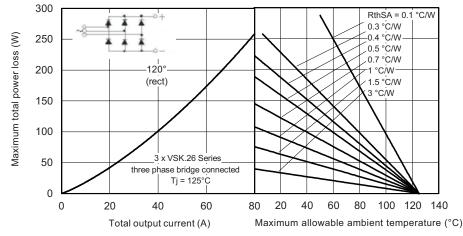


Fig. 9 - On-State Power Loss Characteristics

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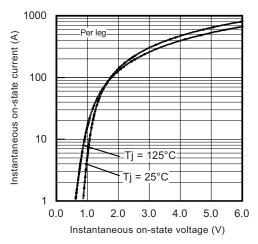


Fig. 10 - On-State Voltage Drop Characteristics

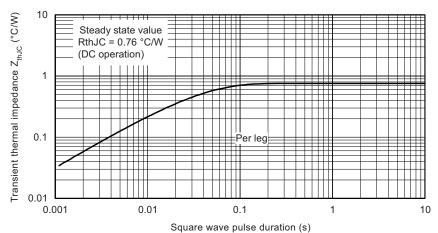


Fig. 11 - Thermal Impedance Z_{thJC} Characteristics

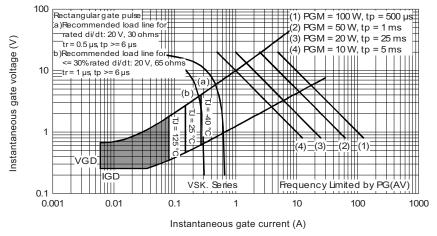
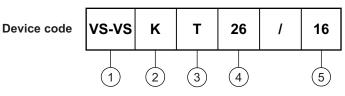


Fig. 12 - Gate Characteristics

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ORDERING INFORMATION TABLE



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Module type

Circuit configuration (see Circuit Configuration table)

Current code (26 A)

Voltage code (see Voltage Ratings table)

Note

To order the optional hardware go to www.vishay.com/doc?95172

CIRCUIT DESCRIPTION	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING
Two SCRs doubler circuit	Т	VSKT (1) 1 1 1 1 1 1 1 1 1 1 1 1
SCR/diode doubler circuit, positive control	Н	VSKH (1) (1) (2) (2) (3) (3) (3) (4) (4) (5)
SCR/diode doubler circuit, negative control	L	VSKL (1) ~ (2) (2) (2) (3) (3) (6) (82 G2 (7) (6)

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CIRCUIT CONFIGURATION	ON	
CIRCUIT DESCRIPTION	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING
SCR/diode common anodes	N	VSKN (1) (2) (3) (3) (4) (5)
Two SCRs common cathodes	U	VSKU (1) 1 (2) (2) (3) (3) (6) (7) (6)
Two SCRs common anodes	V	VSKV (1) 1 (2) (2) (3) (3) (4) (5) (7) (6)

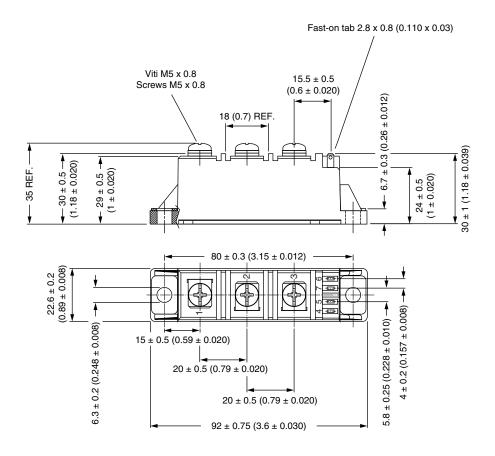
LINKS TO RELAT	ED DOCUMENTS
Dimensions	www.vishay.com/doc?95368



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ADD-A-PAK Generation VII - Thyristor

DIMENSIONS in millimeters (inches)





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